

No Shield	Forward Clipper	Backward Clipper
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Features

- RoHS compliant
- Compliant with IEEE 802.3z Gigabit Ethernet standard
- Compliant with Fiber Channel 100-SM-LC-L standard
- Industry standard 1×9 footprint
- SC duplex connector
- Single power supply 3.3 V/5V
- Differential LVPECL/PECL inputs and outputs
- Compatible with solder and aqueous wash processes
- Class 1 laser product complies with EN 60825-1

Ordering Information

PART NUMBER	INPUT/OUTPUT	SIGNAL DETECT	VOLTAGE	CLIPPER	TEMPERATURE
LS32-CAS-PC-N	DC/DC	LVPECL/PECL	3.3V/5V		0° C to 70 $^{\circ}$ C
LS32-CAS-PC-B	DC/DC	LVPECL/PECL	3.3V/5V	Backward	0° C to 70° C
LS32-CAS-PC-F	DC/DC	LVPECL/PECL	3.3V/5V	Forward	0° C to 70 $^{\circ}$ C
LS32-CAS-TC-N	AC/AC	TTL	3.3V/5V		0° C to 70 $^{\circ}$ C
LS32-CAS-TC-B	AC/AC	TTL	3.3V/5V	Backward	0° C to 70 $^{\circ}$ C
LS32-CAS-TC-F	AC/AC	TTL	3.3V/5V	Forward	0° C to 70 $^{\circ}$ C

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Absolute Maximum Ratings

PARAMETER	SYMBOL	MIN	MAX	UNITS	NOTE
Storage Temperature	T_S	-40	85	°C	
Supply Voltage	Vcc	-0.5	6.0	V	
Input Voltage	V_{IN}	-0.5	Vcc	V	
Output Current	I_o		50	mA	
Operating Current	I_{OP}		400	mA	
Soldering Temperature	T _{SOLD}		260	°C	10 seconds on leads

Operating Environment

PARAMETER	SYMBOL	MIN	MAX	UNITS	NOTE
Ambient Operating Temperature	T_{AMB}	0	70	°C	
Supply Voltage	Vcc	3.1	5.25	V	

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Transmitter Electro-optical Characteristics

Vcc = 3.1	Vto	5 25 V	т <u>–</u>	0°C to	70°C
vcc = 3.1	ινιο	5.25 V	=	υια)/U U

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SYMBOL	MIN	TYP.	MAX	UNITS	NOTE
Pout	-9.5		-3	dBm	Average
1 0111	7.0			ubiii	Trotago
ER	9			dB	
λ_C	1270	1310	1355	nm	
$\Delta\lambda$			2.5	nm	
T _{r, f}			260	ps	
TJ			227	ps	
Compliant with IEEE802.3z					
I_{CC}			120	mA	Note 1
$V_{IH} - V_{CC}$	-1.1		-0.74	V	Note 2
$V_{IL} - V_{CC}$	-2.0		-1.58	V	Note 2
V_{DIFF}	0.3		1.6	V	Note 2
	SYMBOLPoutER λ_c $\Delta\lambda$ $T_{r,f}$ TJIcc $V_{IH} - V_{CC}$ $V_{IL} - V_{CC}$	SYMBOL MIN $Pout$ -9.5 ER 9 λ_c 1270 $\Delta\lambda$ $T_{r,f}$ TJ I_{CC} $V_{IH} - V_{CC}$ -1.1 $V_{IL} - V_{CC}$ -2.0	SYMBOL MIN TYP. Pout -9.5 ER 9 λ_C 1270 1310 $\Delta\lambda$ $T_{r,f}$ TJ I_{CC} $V_{IH} - V_{CC}$ -1.1 $V_{IL} - V_{CC}$ -2.0	SYMBOL MIN TYP. MAX Pout -9.5 -3 ER 9 λ_C 1270 1310 1355 $\Delta\lambda$ 2.5 $T_{r,f}$ 260 TJ 227 Compliant with IEEI Icc I_{CC} $V_{IH} - V_{CC}$ -1.1 $V_{IL} - V_{CC}$ -2.0	SYMBOL MIN TYP. MAX UNITS Pout -9.5 -3 dBm ER 9 3 dB λ_C 1270 1310 1355 nm $\Delta\lambda$ 2.5 nm $\Delta\lambda$ 260 ps TJ 227 ps Compliant with IEEE802.3z I I I I $V_{IH} - V_{CC}$ -1.1 -0.74 V $V_{IL} - V_{CC}$ -2.0 -1.58 V

Note 1: Not including the terminations.

Note 2: These inputs are compatible with 10K, 10KH and 100K ECL and PECL input.

Note 3: Due to the dual media (single-mode and multi-mode) support of the LX transmitter, fulfillment of this specification requires a single-mode fiber offset-launch mode-conditioning patch cord described in IEEE802.3z clause 38.11.4 for MMF operation. This patch cord is not for single-mode operation.

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Receiver electro-optical characteristics

Vcc = 3.1 V to 5.2	25 V. T. = 0	°C to 7(°C·
V (0 - 3.1 + 10 3.4	43 V.I.A — V	<i>, , , , , , , , , , , , , , , , , , , </i>	, C.

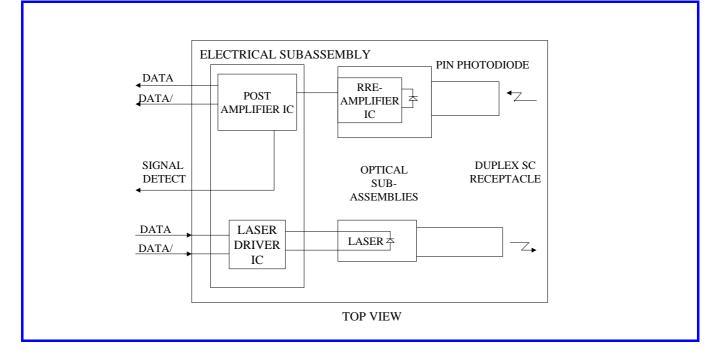
P_{IN}					NOTE
114	-3			dBm	$BER < 10^{-12}$
P_{IN}			-20	dBm	$BER < 10^{-12}$
λ_C	1260		1610	nm	
ORL	12			dB	
P_A			-20	dBm	
P_D	-35			dBm	
$P_A - P_D$	1.0			dB	
			-14.4	dBm	
$V_{OH} - V_{CC}$	-1.1		-0.74	V	Note 1
$V_{OL} - V_{CC}$	-2.0		-1.58	V	Note 1
V_{OH}	V _{CC} -0.8		Vcc	V	
V_{OL}	0		0.5	V	
I_{CC}			120	mA	
$T_{r,f}$			0.35	ns	
$V_{OH} - V_{CC}$	-1.1		-0.74	V	Note 1
$V_{OL} - V_{CC}$	-2.0		-1.58	V	Note 1
V_{DIFF}	0.3		1.6	V	
	λ_{C} ORL P_{A} P_{D} $P_{A} - P_{D}$ $V_{OH} - V_{CC}$ $V_{OL} - V_{CC}$ V_{OL} I_{CC} $T_{r,f}$ $V_{OL} - V_{CC}$ $V_{OH} - V_{CC}$	$\begin{array}{c ccc} \lambda_{C} & 1260 \\ \hline \\ ORL & 12 \\ \hline \\ P_{A} & \\ \hline \\ P_{D} & -35 \\ \hline \\ P_{D} & -35 \\ \hline \\ P_{A} - P_{D} & 1.0 \\ \hline \\ \hline \\ V_{OH} - V_{CC} & -1.1 \\ \hline \\ V_{OH} - V_{CC} & -2.0 \\ \hline \\ \hline \\ V_{OL} & 0 \\ \hline \\ V_{OL} & 0 \\ \hline \\ I_{CC} & \\ \hline \\ T_{r,f} & \\ \hline \\ V_{OH} - V_{CC} & -1.1 \\ \hline \\ V_{OL} - V_{CC} & -2.0 \\ \hline \end{array}$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	λ_c 1260 λ_c 1260 1610 nm ORL 12 dB P_A -20 dBm P_D -35 -20 dBm P_D -35 dBm $P_A - P_D$ 1.0 dB $P_A - P_D$ 1.0 dB V_{A-P_D} 1.0 dB $V_{OH} - V_{CC}$ -1.1 -0.74 V $V_{OL} - V_{CC}$ -2.0 -1.58 V V_{OL} 0 0.5 V I_{CC} 0.35 ns $V_{OL} - V_{CC}$ -1.1 -0.74 V $V_{OL} - V_{CC}$ -1.1 -0.74 V $V_{OL} - V_{CC}$ -2.0 -1.58 V

Note 1: These outputs are compatible with 10K, 10KH and 100K ECL and PECL input.

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Block Diagram of Transceiver



Transmitter Section

The transmitter section consists of a 1310 nm InGaAsP laser in an eye safe optical subassembly (OSA) which mates to the fiber cable. The laser OSA is driven by a LD driver IC which converts differential input LVPECL/PECL logic signals into an analog laser driving current.

Receiver Section

The receiver utilizes an InGaAs PIN photodiode mounted together with a trans-impedance preamplifier IC in an OSA. This OSA is connected to a circuit providing post-amplification quantization, and optical signal detection.

Receiver Signal Detect

Signal Detect is a basic fiber failure indicator. This is a single-ended LVPECL/PECL or TTL output. As the input optical power is decreased, Signal Detect will switch from high to low (deassert point) somewhere between sensitivity and the no light input level. As the input optical power is increased from very low levels, Signal Detect will switch back from low to high (assert point). The assert level will be at least 1.0 dB higher than the deassert level.

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Connection Diagram

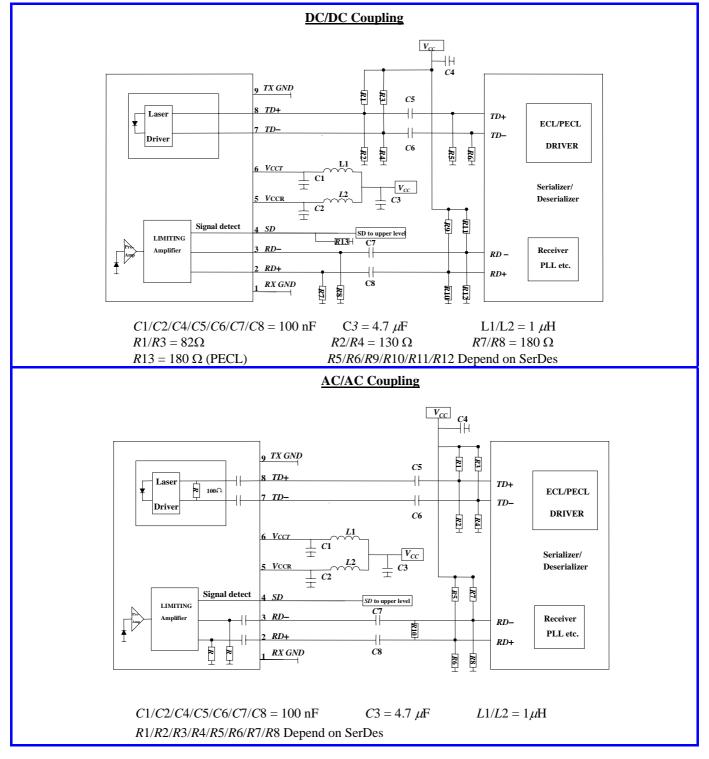
in-Out		
	1. <i>RX GND</i> 2. <i>RD</i> +	O ^{N/C}
	3. <i>RD</i> -	C C
	4. SD 5. Vccr	TOP VIEW
	6. VCCT	
	7. TD- 8. TD+	∩ N/C
	9. TX GND	0

PIN	SYMBOL	DESCRIPTION
1	RX GND	Receiver Signal Ground.
-	KA UND	Directly connect this pin to the receiver ground plane.
		<i>RD</i> + is an open-emitter output circuit.
2	RD+	Terminate this high-speed differential LVPECL/PECL output with standard LVPECL/PECL techniques
		at the follow-on device input pin. (See recommended circuit schematic)
		<i>RD</i> – is an open-emitter output circuit.
3	RD-	Terminate this high-speed differential LVPECL/PECL output with standard LVPECL/PECL techniques
		at the follow-on device input pin. (See recommended circuit schematic)
		Signal Detect.
		Normal optical input levels to the receiver result in a logic "1" output, V_{OH} , asserted. Low input optical
		levels to the receiver result in a fault condition indicated by a logic "0" output V_{OL} , deasserted Signal
4	SD	Detect is a single-ended LVPECL/PECL or TTL output. SD can be terminated with LVPECL/PECL
	52	techniques via 50 Ω to V_{CCR} – 2 V. Alternatively, SD can be loaded with a 180 Ω resistor to RX GND to
		conserve electrical power with small compromise to signal quality. If Signal Detect output is not used,
		leave it open-circuited. This Signal Detect output can be used to drive a LVPECL/PECL input on an
		upstream circuit, such as, Signal Detect input or Loss of Signal-bar.
_		Receiver Power Supply.
5	V_{CCR}	Provide +3.3 Vdc via the recommended receiver power supply filter circuit. Locate the power supply
		filter circuit as close as possible to the V_{CCR} pin.
		Transmitter Power Supply.
6	V_{CCT}	Provide +3.3 Vdc via the recommended transmitter power supply filter circuit. Locate the power supply
		filter circuit as close as possible to the V_{CCT} pin.
_		Transmitter Data In-Bar.
7	TD-	Terminate this high-speed differential LVPECL/PECL input with standard LVPECL/PECL techniques at
		the transmitter input pin. (See recommended circuit schematic)
-		Transmitter Data In.
8	TD+	Terminate this high-speed differential LVPECL/PECL input with standard LVPECL/PECL techniques at
		the transmitter input pin. (See recommended circuit schematic)
0		Transmitter Signal Ground.
9	TX GND	Directly connect this pin to the transmitter signal ground plane. Directly connect this pin to the
		transmitter ground plane.

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Recommended Circuit Schematic



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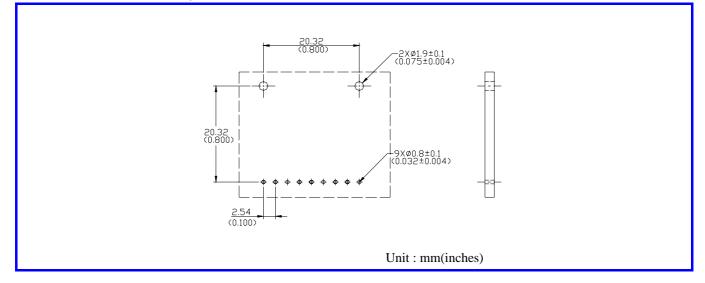
In order to get proper functionality, a recommended circuit is provided in above recommended circuit schematic. When designing the circuit interface, there are a few fundamental guidelines to follow.

- (1) The differential data lines should be treated as 50Ω Micro strip or strip line transmission lines. This will help to minimize the parasitic inductance and capacitance effects. Locate termination at the received signal end of the transmission line. The length of these lines should be kept short and of equal length.
- (2) For the high speed signal lines, differential signals should be used, not single-ended signals, and these differential signals need to be loaded symmetrically to prevent unbalanced currents which will cause distortion in the signal.
- (3) Multi layer plane PCB is best for distribution of V_{CC} , returning ground currents, forming transmission lines and shielding, Also, it is important to suppress noise from influencing the fiber-optic transceiver performance, especially the receiver circuit.
- (4) A separate proper power supply filter circuits shown in Figure for the transmitter and receiver sections. These filter circuits suppress Vcc noise over a broad frequency range, this prevents receiver sensitivity degradation due to V_{CC} noise.
- (5) Surface-mount components are recommended. Use ceramic bypass capacitors for the 0.1 μ F capacitors and a surface-mount coil inductor for 1 μ H inductor. Ferrite beads can be used to replace the coil inductors when using quieter V_{CC} supplies, but a coil inductor is recommended over a ferrite bead. All power supply components need to be placed physically next to the V_{CC} pins of the receiver and transmitter.
- (6) Use a good, uniform ground plane with a minimum number of holes to provide a low-inductance ground current return for the power supply currents.

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Recommended Board Layout Hole Pattern



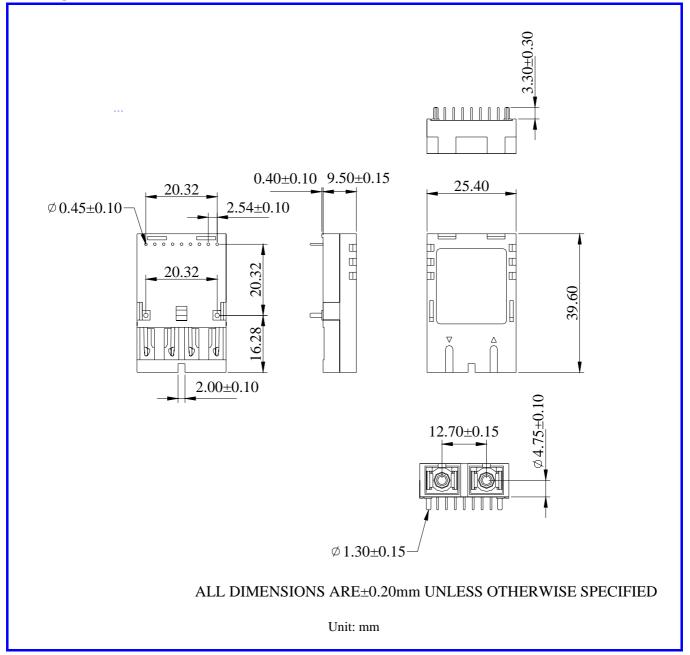
This transceiver is compatible with industry standard wave or hand solder processes. After wash process, all moisture must be completely remove from the module. The transceiver is supplied with a process plug to prevent contamination during wave solder and aqueous rinse as well as during handling, shipping or storage.

Solder fluxes should be water-soluble, organic solder fluxes. Recommended cleaning and degreasing chemicals for these transceivers are alcohol's (methyl, isopropyl, isobutyl), aliphatics (hexane, heptane) and other chemicals, such as soap solution or naphtha. Do not use partially halogenated hydrocarbons for cleaning/degreasing.

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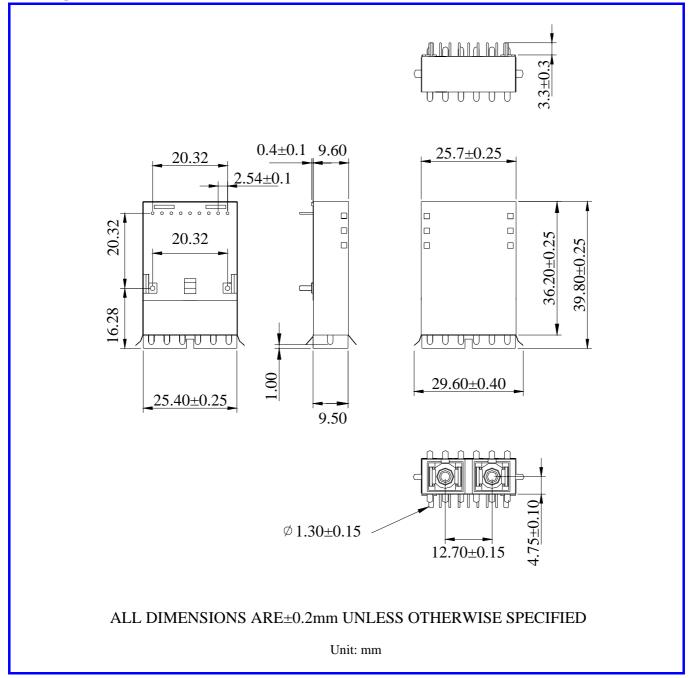
Drawing Dimensions- No Shield



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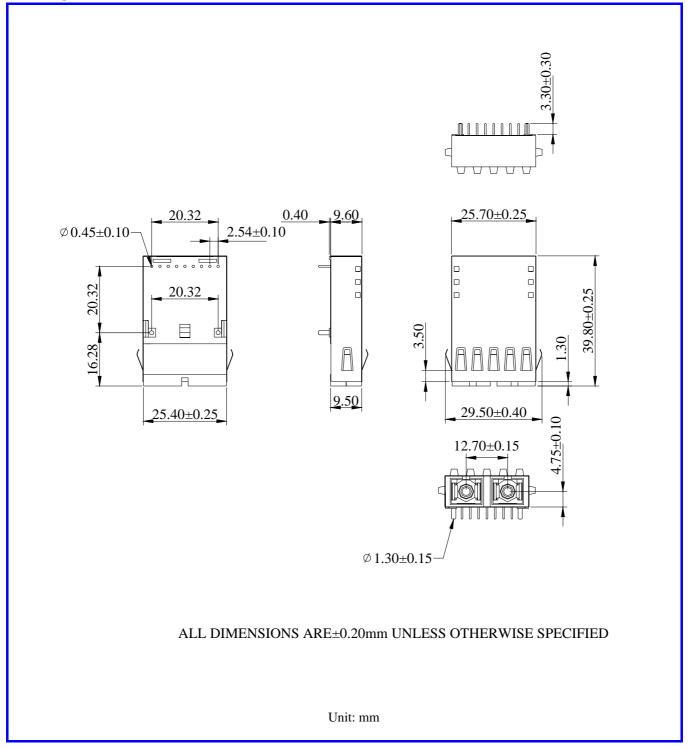
Drawing Dimensions- Forward Shield



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Drawing Dimensions- Backward Shield



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Eye Safety Mark

The LS3 series Single-mode transceiver is a class 1 laser product. It complies with EN 60825-1 and FDA 21 CFR 1040.10 and 1040.11. In order to meet laser safety requirements the transceiver shall be operated within the Absolute Maximum Ratings. <u>Caution</u> All adjustments have been done at the factory before the shipment of the devices. No maintenance and user serviceable part is required. Tampering with and modifying the performance of the device will result in voided product warranty.	Required Mark Class 1 Laser Product Complies with 21 CFR 1040.10 and 1040.11				
Note : All information contained in this document is subject to change without notice.					

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